



EV 444356600

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. ....09/961,114  
Filing Date ..... 09/20/2001  
Inventorship .....Perino et al.  
Applicant..... Microsoft Corporation  
Group Art Unit .....2833  
Examiner ..... Figueroa, Felix O  
Attorney's Docket No. .... RB1-035USC3  
Title: Chip Socket Assembly and Chip File Assembly for Semiconductor Chips

**RESPONSE TO OFFICE ACTION DATED JANUARY 20, 2004**

To: Commissioner of Patents and Trademarks  
Alexandria VA 22313-1450

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